### SN74ALS156 DECODER/DEMULTIPLEXER WITH OPEN-COLLECTOR OUTPUTS SDAS099C – JUNE 1986 – REVISED MAY 1996

	plications: Dual 2-Line to 4-Line Decoder	D OR N P (TOP )	
	Dual 1-Line to 4-Line Demultiplexer		<u>דה,</u>
-	3-Line to 8-Line Decoder I-Line to 8-Line Demultiplexer	1 <u>C</u> <u> </u> 1 1 <u>G</u> <u> </u> 2	16 V <u>C</u> C 15 2C
	lividual Strobes Simplify Cascading for	B 3	14 2G
	coding or Demultiplexing Larger Words	1Y3 🛛 4	13 A
	ckage Options Include Plastic	1Y2 5	12 2Y3
Sm	all-Outline (D) Packages and Standard	1Y1 [] 6 1Y0 [] 7	11 2Y2 10 2Y1
Pla	stic (N) 300-mil DIPs	GND 8	9 2Y0
docarint	ion		

### description

One of the main applications of the SN74ALS156 is as a dual 1-line to 4-line decoder/demultiplexer with individual strobes ( $\overline{G}$ ) and common binary-address inputs in a single 16-pin package. When both sections are enabled, the common binary-address inputs sequentially select and route associated input data to the appropriate output of each section. The individual strobes permit enabling or disabling each of the 4-bit sections, as desired.

Data applied to input 1C is inverted at its outputs and data applied at input  $2\overline{C}$  is not inverted through its outputs. The inverter following the 1C data input permits use of the SN74ALS156 as a 3-line to 8-line demultiplexer without external gating. All inputs are clamped with high-performance Schottky diodes to suppress line ringing and simplify system design.

The SN74ALS156 is characterized for operation from 0°C to 70°C.



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#### **Function Tables**

	I	NPUTS		OUTPUTS						
SELECT		STROBE	DATA	0017013						
В	Α	1 <mark>G</mark>	1C	1Y0	1Y1	1Y2	1Y3			
Х	Х	Н	Х	Н	Н	Н	Н			
L	L	L	Н	L	Н	Н	Н			
L	Н	L	Н	н	L	Н	Н			
н	L	L	Н	н	Н	L	Н			
н	н	L	н	н	н	н	L			
Х	Х	Х	L	Н	Н	Н	Н			

#### 2-LINE TO 4-LINE DECODER OR 1-LINE TO 4-LINE DEMULTIPLEXER

#### 2-LINE TO 4-LINE DECODER OR **1-LINE TO 4-LINE DEMULTIPLEXER**

	I	NPUTS											
SELECT		STROBE	DATA	OUTPUTS									
В	Α	2 <mark>G</mark>	2 <mark>C</mark>	2Y0	2Y1	2Y2	2Y3						
Х	Х	Н	Х	Н	Н	Н	Н						
L	L	L	L	L	Н	Н	н						
L	Н	L	L	н	L	Н	н						
н	L	L	L	н	Н	L	н						
н	н	L	L	н	Н	Н	L						
Х	Х	Х	Н	н	Н	Н	Н						

#### 3-LINE TO 8-LINE DECODER OR **1-LINE TO 8-LINE DEMULTIPLEXER**

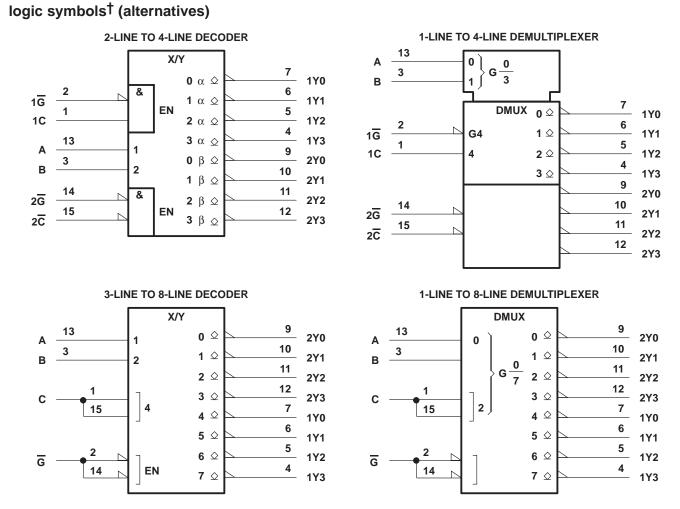
	IN	PUTS					OUT	PUTS			
	SELECT		STROBE OR	0	1	2	3	4	5	6	7
c†	В	Α	DATA G‡	2Y0	2Y1	2Y2	2Y3	1Y0	1Y1	1Y2	1Y3
Х	Х	Х	Н	Н	Н	Н	Н	Н	Н	Н	Н
L	L	L	L	L	Н	Н	Н	L	Н	Н	Н
L	L	Н	L	Н	L	Н	Н	Н	L	Н	Н
L	Н	L	L	Н	Н	L	Н	Н	Н	Н	Н
L	Н	Н	L	Н	Н	Н	L	Н	Н	Н	Н
н	L	L	L	Н	Н	Н	Н	L	Н	Н	Н
н	L	Н	L	Н	Н	Н	Н	Н	L	Н	Н
н	Н	L	L	Н	Н	L	Н	Н	Н	L	Н
Н	Н	Н	L	Н	Н	Н	L	Н	Н	Н	L

 $\frac{1}{C} = \text{inputs } 1C \text{ and } 2C \text{ connected together}$  $\frac{1}{G} = \text{inputs } 1G \text{ and } 2G \text{ connected together}$ 



#### **SN74ALS156** DECODER/DEMULTIPLEXER WITH OPEN-COLLECTOR OUTPU ITS

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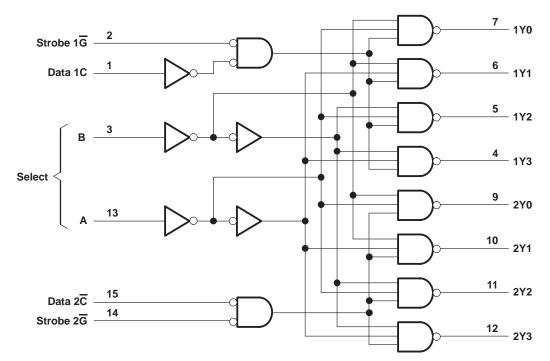
<sup>†</sup> These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



# SN74ALS156 DECODER/DEMULTIPLEXER WITH OPEN-COLLECTOR OUTPUTS

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## logic diagram (positive logic)



### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage, V <sub>CC</sub>
Input voltage, V <sub>1</sub>
Operating free-air temperature range, T <sub>A</sub>
Storage temperature range, T <sub>stg</sub> –65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### recommended operating conditions

		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	V
VIH	High-level input voltage	2			V
$V_{IL}$	Low-level input voltage			0.8	V
VOH	High-level output voltage			5.5	V
IOL	Low-level output current			8	mA
TA	Operating free-air temperature	0		70	°C



# **SN74ALS156 DECODER/DEMULTIPLEXER** WITH OPEN-COLLECTOR OUTPUTS SDAS099C - JUNE 1986 - REVISED MAY 1996

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CO	TEST CONDITIONS			
VIK	$V_{CC} = 4.5 V,$	lj = – 18 mA		-1.5	V
N .		$I_{OL} = 4 \text{ mA}$	0.25	0.4	
VOL	$V_{CC} = 4.5 V$	I <sub>OL</sub> = 8 mA	0.35	0.5	V
IОН	$V_{CC} = 4.5 V,$	V <sub>OH</sub> = 5.5 V		0.1	mA
lj	$V_{CC} = 5.5 V,$	$V_{I} = 7 V$		0.1	mA
ЧΗ	V <sub>CC</sub> = 5.5 V,	VI = 2.7 V		20	μA
١ <sub>١L</sub>	V <sub>CC</sub> = 5.5 V,	VI = 0.4 V		-0.1	μA
ICCL	V <sub>CC</sub> = 5.5 V		5	9	mA

<sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}, \text{ T}_{A} = 25^{\circ}\text{C}.$ 

## switching characteristics (see Figure 1)

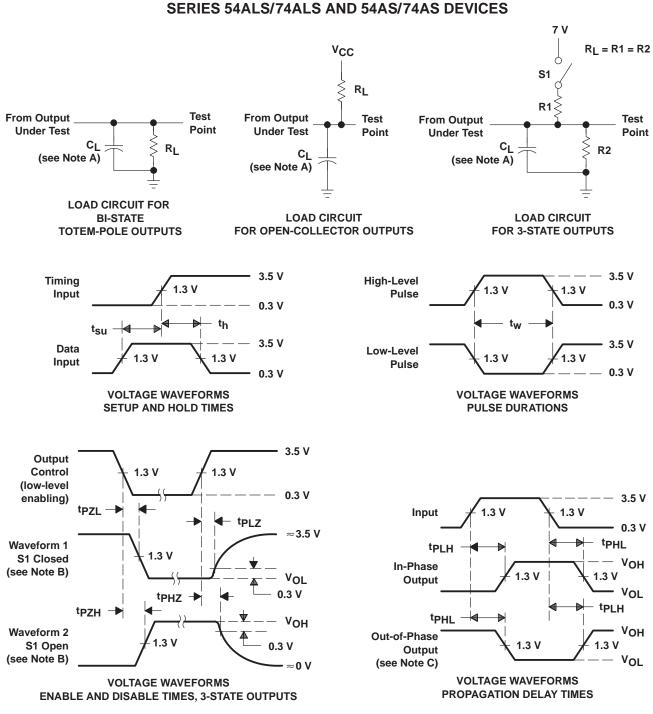
PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 4.5$ $C_{L} = 50 \text{ pl}$ $R_{L} = 500 \text{ s}$ $T_{A} = \text{MIN}$	$V_{CC} = 4.5 V \text{ to } 5.5 V, \\ C_{L} = 50 \text{ pF}, \\ R_{L} = 500 \Omega, \\ T_{A} = \text{MIN to MAX}^{\ddagger}$			
			MIN	MAX			
<sup>t</sup> PLH			7	55			
<sup>t</sup> PHL	А, В	1Y, 2Y	6	25	ns		
<sup>t</sup> PLH	10	1Y	7	50			
<sup>t</sup> PHL	1C	1 Y	6	23	ns		
<sup>t</sup> PLH	1 <mark>G</mark>	47	7	38			
<sup>t</sup> PHL	16	1Y	6	22	ns		
<sup>t</sup> PLH	2 <del>0</del> , 2 <del>0</del>	2Y	7	38			
<sup>t</sup> PHL	20, 20	21	6	22	ns		

<sup>‡</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



# SN74ALS156 DECODER/DEMULTIPLEXER WITH OPEN-COLLECTOR OUTPUTS

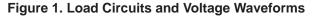
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PARAMETER MEASUREMENT INFORMATION

NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
   C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- C. When measuring propagation delay items of 3-state outputs, switch S its open.
- D. All input pulses have the following characteristics: PRR  $\leq$  1 MHz, t<sub>r</sub> = t<sub>f</sub> = 2 ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.







## **PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN74ALS156D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS156	Samples
SN74ALS156DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS156	Samples
SN74ALS156DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS156	Samples
SN74ALS156DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS156	Samples
SN74ALS156N	ACTIVE	PDIP	Ν	16	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS156N	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.



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## TAPE AND REEL INFORMATION





# QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALS156DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1



# PACKAGE MATERIALS INFORMATION

19-Mar-2008



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ALS156DR	SOIC	D	16	2500	333.2	345.9	28.6

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



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# D (R-PDSO-G16) PLASTIC SMALL OUTLINE Stencil Openings (Note D) Example Board Layout (Note C) –16x0,55 -14x1,27 -14x1,27 16x1,50 5,40 5.40 Example Non Soldermask Defined Pad Example Pad Geometry (See Note C) 0,60 .55 Example 1. Solder Mask Opening (See Note E) -0,07 All Around

NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



# N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



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